

UC1845A-SP QML V 类 耐辐射电流模式 PWM 控制器

1 特性

- 符合 QML V 类 (QMLV) 标准, SMD 5962-86704
- 5962P8670411Vxx: ⁽¹⁾
 - 抗辐射加固保障 (RHA) 能力高达 30-krad(Si) 总电离剂量 (TID)
 - 通过了 45krad/LDR (10mrad/s) 测试条件 (符合 MIL-STD-883 测试方法 1019.9 的 3.13.3.b 小节定义的 1.5 倍过量测试) 下的功能性测试且在规定的后辐射参数限值范围内
 - 展现出低剂量率灵敏度 ⁽²⁾但在 30krad 总剂量水平下仍保持在 MIL-STD-883, TM1019 所允许的预辐射电气限制范围内
- 经过优化适用于 DC-DC 转换器 应用
- 低启动电流 (< 0.5mA)
- 修整的振荡器放电电流
- 自动前馈补偿
- 逐脉冲电流限制
- 增强型负载响应特性
- 带滞后的欠压闭锁 (UVLO) 保护
- 双脉冲抑制
- 高电流推挽式输出
- 内部调整的带隙参考
- 500kHz 工作频率
- 低 R_O 误差放大器
- 支持军用级温度范围 (-55°C 至 125°C)

- (1) 改进的 TID 辐射性能仅适用于抗辐射加固保障 (RHA) 器件类型 11。
- (2) 受影响的参数参考输出电压, V_{REF} 辐射漂移曲线 (请参见 [V_{REF} 辐射漂移曲线](#))。

2 应用

- 抗辐射加固型 DC-DC 转换器
- 卫星本体和有效载荷
- 太空运载火箭
- 水下布线
- 支持多种拓扑结构:
 - 反激、正激、降压、升压
 - 推挽、半桥、全桥 (采用外部接口电路时)

3 说明

UC1845A-SP 控制 IC是与 UC184x 系列引脚兼容的抗辐射加固版。它主要适用于卫星和其他恶劣环境应用。该器件提供了控制电流模式开关电源所必需的特性,并改进了多种功能。额定启动电流低于 0.5mA,振荡器放电电流调整为 8.3mA。UVLO 期间,输出级在低于 1.2V 的电压下至少具有 10mA 的灌电流能力 (V_{CC} 高于 5V)。

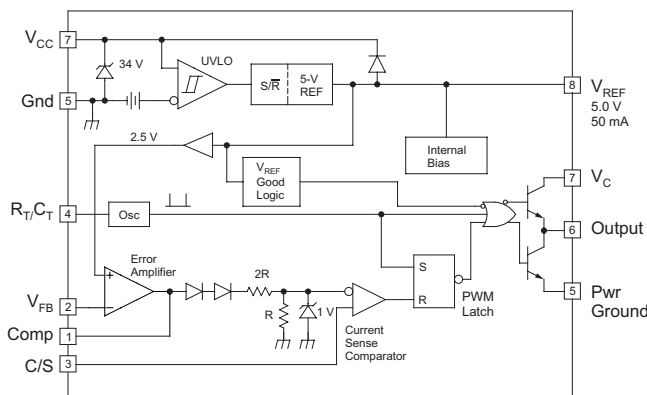
器件比较表显示了该系列各成员器件间的不同之处。要订购辐射改进型版本 (如已提供), 请参考相应的产品数据表。

器件信息⁽¹⁾

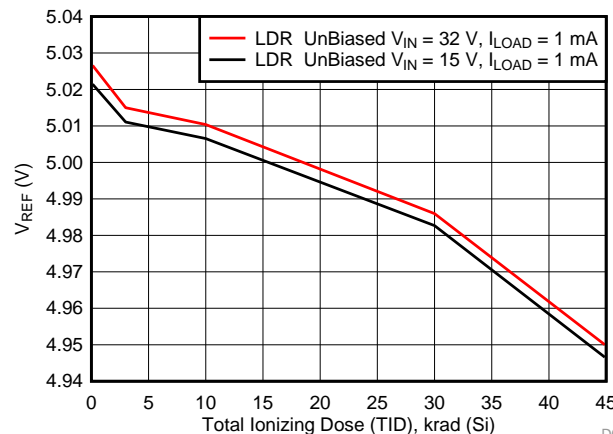
器件型号	封装	封装尺寸 (标称值)
UC1845A-SP	CDIP/JG (8)	6.67mm x 9.60mm
	LCCC/FK (20)	8.89mm x 8.89mm
	CFP/HKU (10)	6.48mm x 7.02mm

- (1) 如需了解所有可用封装, 请参阅数据表末尾的可订购产品附录。

简化电路原理图



V_{REF} 辐射漂移曲线



D001



目录

1	特性	1	8.3	Feature Description	7
2	应用	1	8.4	Device Functional Modes	12
3	说明	1	9	Application and Implementation	13
4	修订历史记录	2	9.1	Application Information	13
5	Device Comparison Table	3	9.2	Typical Application	13
6	Pin Configuration and Functions	3	10	Power Supply Recommendations	20
7	Specifications	4	11	Layout	20
7.1	Absolute Maximum Ratings	4	11.1	Layout Guidelines	20
7.2	ESD Ratings	4	11.2	Layout Example	21
7.3	Recommended Operating Conditions	4	12	器件和文档支持	22
7.4	Thermal Information	4	12.1	接收文档更新通知	22
7.5	Electrical Characteristics	5	12.2	社区资源	22
7.6	Typical Characteristics	6	12.3	商标	22
8	Detailed Description	7	12.4	静电放电警告	22
8.1	Overview	7	12.5	术语表	22
8.2	Functional Block Diagram	7	13	机械、封装和可订购信息	22

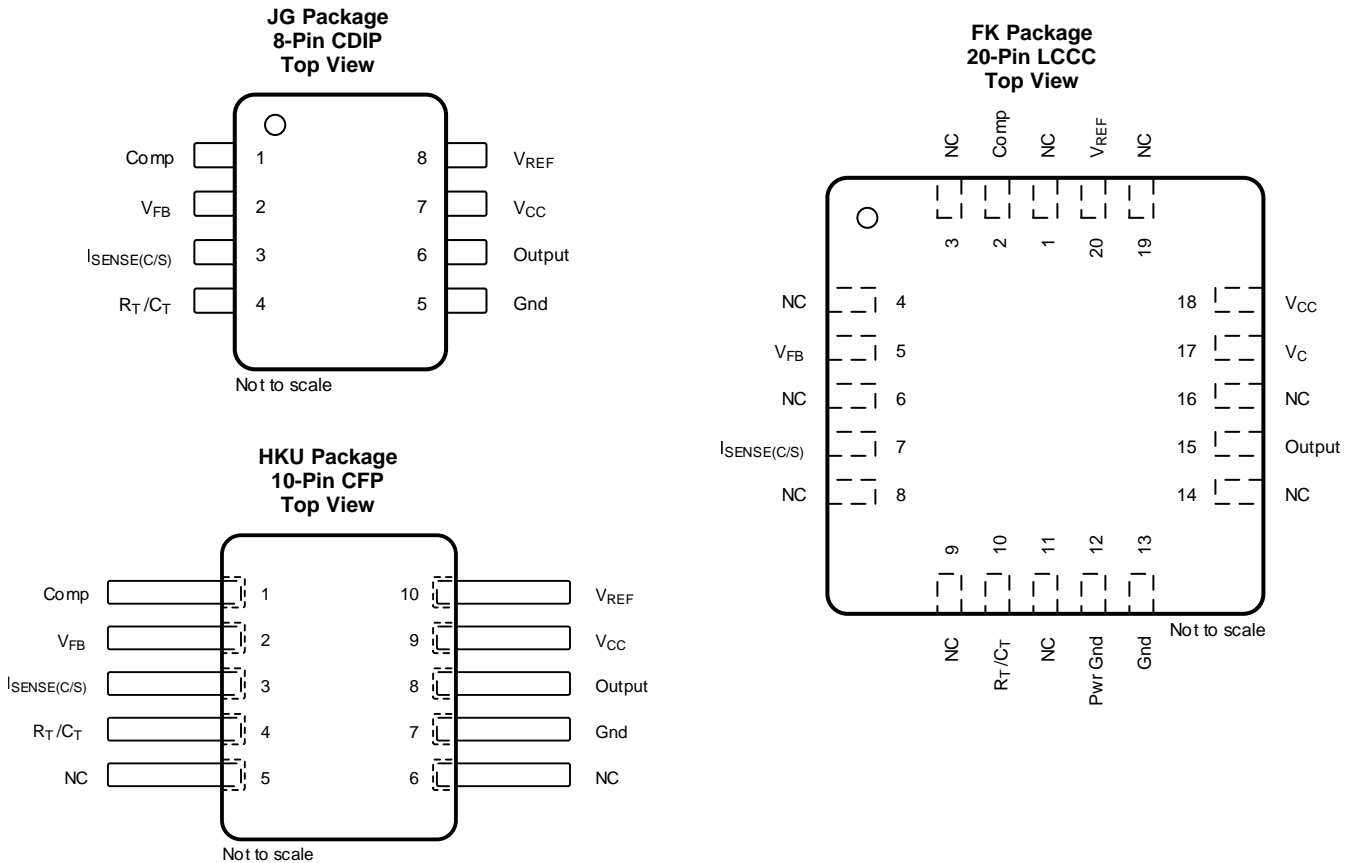
4 修订历史记录

Changes from Original (May 2015) to Revision A	Page
• Changed the <i>Pin Configuration</i> images	3
• Changed CT (pF) To: CT (μF) in Equation 1	15

5 Device Comparison Table

PART NO.	UVLO ON	UVLO OFF	MAXIMUM DUTY CYCLE
UC1842A	16 V	10 V	<100%
UC1843A	8.5 V	7.9 V	<100%
UC1844A	16 V	10 V	<50%
UC1845A	8.5 V	7.9 V	<50%

6 Pin Configuration and Functions



Pin Functions

PIN				I/O	DESCRIPTION
NAME	CDIP	LCCC	CFP		
Comp	1	2	1	I	Error amplifier output.
V _{FB}	2	5	2	I	Voltage feedback input to error amplifier.
I _{SENSE(C/S)}	3	7	3	I	Current sense comparator input pin.
R _T /C _T	4	10	4	I	RC time constant input to oscillator.
NC	—	1, 3, 4, 6, 8, 9, 11, 14, 16, 19	5, 6	—	No connect.
Pwr Gnd	—	12	—	—	Output section ground.
Gnd	5	13	7	—	Ground.
Output	6	15	8	O	Regulated output.
V _C	—	17	—	—	Output section supply voltage.
V _{CC}	7	18	9	—	Unregulated supply voltage.

Pin Functions (continued)

PIN				I/O	DESCRIPTION
NAME	CDIP	LCCC	CFP		
V _{REF}	8	20	10	O	5-V internally generated reference.

7 Specifications

7.1 Absolute Maximum Ratings⁽¹⁾⁽²⁾

over operating free-air temperature (unless otherwise noted)

	MIN	MAX	UNIT
V _{CC} Supply voltage, low-impedance source		30	V
V _I Input voltage (V _{FB} , I _{SENSE})	−0.3	6.3	V
Supply current	Self limiting		
I _O Output current		±1	A
Error amplifier output sink current		10	mA
Output energy (capacitive load)		5	μJ
P _D Power dissipation (T _A = 25°C)		1	W
T _J Junction temperature		150	°C
T _{stg} Storage temperature	−65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to ground. Currents are positive in, negative out of the specified terminal.

7.2 ESD Ratings

	VALUE	UNIT
V _(ESD) Electrostatic discharge Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±4000	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

 over operating free-air temperature range (T_A = T_J = −55°C to 125°C), unless otherwise noted

	MIN	MAX	UNIT
V _{CC} Supply voltage	12	25	V
Sink/source output current (continuous or time average)	0	200	mA
Reference load current	0	20	mA

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		UC1845A-SP			UNIT
		JG (CDIP)	FK (LCCC)	HKU (CFP)	
		8 PINS	20 PINS	10 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	103	—	51.9	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	9.6	9.0	6.6	°C/W
R _{θJB}	Junction-to-board thermal resistance	69.2	—	31.5	°C/W
ψ _{JT}	Junction-to-top characterization parameter	13.9	—	5.42	°C/W
ψ _{JB}	Junction-to-board characterization parameter	73	—	31	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Electrical Characteristics

 $V_{CC} = 15\text{ V}^{(1)}$, $R_T = 10\text{ k}\Omega$, $C_T = 3.3\text{ nF}$, $T_A = T_J = -55^\circ\text{C}$ to 125°C (unless otherwise noted) ⁽²⁾

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
REFERENCE						
Output voltage	$T_J = 25^{\circ}\text{C}$, $I_O = 1\text{ mA}$, $V_{CC} = 15\text{ V}$	5962-8670408VxA	4.95	5	5.06	V
		5962P8670411Vxx Pre-radiation	4.94	5	5.06	
		5962P8670411Vxx Post-radiation	4.85		5.06	
Line regulation	$V_{IN} = 12\text{ to }25\text{ V}$			6	20	mV
Load regulation	$I_O = 1\text{ to }20\text{ mA}$			6	25	mV
Temperature stability ⁽³⁾⁽⁴⁾⁽⁵⁾				0.2	0.4	mV/ $^{\circ}\text{C}$
Total output variation ⁽³⁾	Over line, load, and temperature		4.9		5.1	V
Output noise variation	$10\text{ Hz} \leq f \leq 10\text{ kHz}$, $T_J = 25^{\circ}\text{C}$			50		μV
Long-term stability ⁽⁵⁾	1000 hours, $T_A = 125^{\circ}\text{C}^{(3)}$			5	25	mV
Short-circuit output current			-30	-100	-180	mA
OSCILLATOR						
Initial accuracy	$T_J = 25^{\circ}\text{C}^{(6)}$		47	52	57	kHz
Voltage stability	$V_{CC} = 12\text{ to }25\text{ V}$			0.2%	1%	
Temperature stability	$T_J = -55^{\circ}\text{C}$ to $125^{\circ}\text{C}^{(3)}$			5%		
Amplitude	$V_{RT/CT}$ peak to peak ⁽³⁾			1.7		V
Discharge current	V pin 4 = $2\text{ V}^{(7)}$	$T_J = 25^{\circ}\text{C}$	7.8	8.3	8.8	mA
		$T_J = \text{Full range}$	7.5		8.8	mA
ERROR AMPLIFIER						
Input voltage	$V_{Comp} = 2.5\text{ V}$		2.45	2.50	2.55	V
Input bias current				-0.3	-1	μA
Open-loop voltage gain	$V_O = 2\text{ to }4\text{ V}$		65	90		dB
Unity-gain bandwidth	$T_J = 25^{\circ}\text{C}^{(3)}$		0.7	1		MHz
PSRR	$V_{CC} = 12\text{ to }25\text{ V}$		60	70		dB
Output sink current	$V_{FB} = 2.7\text{ V}$, $V_{Comp} = 1.1\text{ V}$		2	6		mA
Output source current	$V_{FB} = 2.3\text{ V}$, $V_{Comp} = 5\text{ V}$		-0.5	-0.8		mA
High-level output voltage	$V_{FB} = 2.3\text{ V}$, $R_L = 15\text{ k}\Omega$ to ground		5	6		V
Low-level output voltage	$V_{FB} = 2.7\text{ V}$, $R_L = 15\text{ k}\Omega$ to V_{REF}			0.7	1.1	V
CURRENT SENSE						
Gain ⁽⁸⁾⁽⁹⁾			2.85	3	3.15	V/V
Maximum input signal	$V_{Comp} = 5\text{ V}^{(8)}$		0.9	1	1.1	V
PSRR	$V_{CC} = 12\text{ to }25\text{ V}^{(8)}$			70		dB
Input bias current				-2	-10	μA
Delay to output	$V_{ISENSE} = 0\text{ to }2\text{ V}^{(3)}$			150	300	ns

(1) Adjust V_{CC} above the start threshold before setting at 15 V.

(2) See [机械、封装和可订购信息](#) for radiation improved devices.

(3) Parameters ensured by design and/or characterization, if not production tested.

(4) Temperature stability, sometimes referred to as average temperature coefficient, is described by the equation:
Temperature Stability = $(V_{\text{REF}}(\text{max}) - V_{\text{REF}}(\text{min})) / (T_J(\text{max}) - T_J(\text{min}))$. $V_{\text{REF}}(\text{max})$ and $V_{\text{REF}}(\text{min})$ are the maximum and minimum reference voltage measured over the appropriate temperature range. Note that the extremes in voltage do not necessarily occur at the extremes in temperature.

(5) Parameter applies only for 5962-8670408VxA.

(6) Output frequency is one-half oscillator frequency for UC1845A.

(7) This parameter is measured with $R_T = 10\text{ k}\Omega$ to V_{REF} . This contributes approximately 300 μA of current to the measurement. The total current flowing into the R_T or C_T pin will be approximately 300 μA higher than the measured value.

(8) Parameter measured at trip point of latch with $V_{FB} = 0\text{ V}$.

(9) Gain defined as: $G = \Delta V_{\text{Comp}} / \Delta V_{\text{ISENSE}}$; $V_{\text{ISENSE}} = 0\text{ to }0.8\text{ V}$.

Electrical Characteristics (continued)

$V_{CC} = 15\text{ V}^{(1)}$, $R_T = 10\text{ k}\Omega$, $C_T = 3.3\text{ nF}$, $T_A = T_J = -55^\circ\text{C}$ to 125°C (unless otherwise noted) ⁽²⁾

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OUTPUT					
Output low-level voltage	$I_{SINK} = 20\text{ mA}$		0.1	0.4	V
	$I_{SINK} = 200\text{ mA}$		1.5	2.2	
Output high-level voltage	$I_{SOURCE} = -20\text{ mA}$	13	13.5		V
	$I_{SOURCE} = -200\text{ mA}$	12	13.5		
Rise time	$C_L = 1\text{ nF}$, $T_J = 25^\circ\text{C}^{(3)}$		50	150	ns
Fall time	$C_L = 1\text{ nF}$, $T_J = 25^\circ\text{C}^{(3)}$		50	150	ns
UVLO saturation	$V_{CC} = 5\text{ V}$, $I_{SINK} = 10\text{ mA}$		0.7	1.2	V
UNDervoltage LOCKOUT					
Start threshold		7.8	8.4	9	V
Minimum operation voltage after turnon		7	7.6	8.2	V
PWM					
Maximum duty cycle		47%	48%	50%	
Minimum duty cycle				0%	
TOTAL STANDBY CURRENT					
Start-up current			0.3	0.5	mA
Operating supply current	$V_{FB} = V_{ISENSE} = 0\text{ V}$		11	17	mA
V_{CC} Zener voltage	$I_{CC} = 25\text{ mA}$	30	34		V

7.6 Typical Characteristics

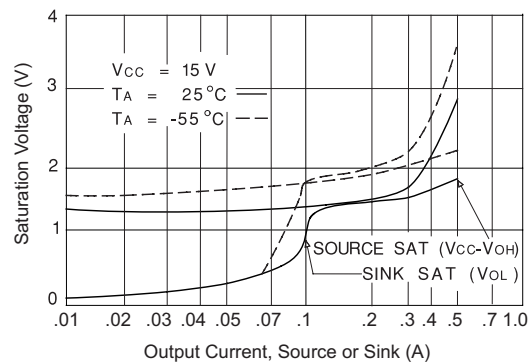


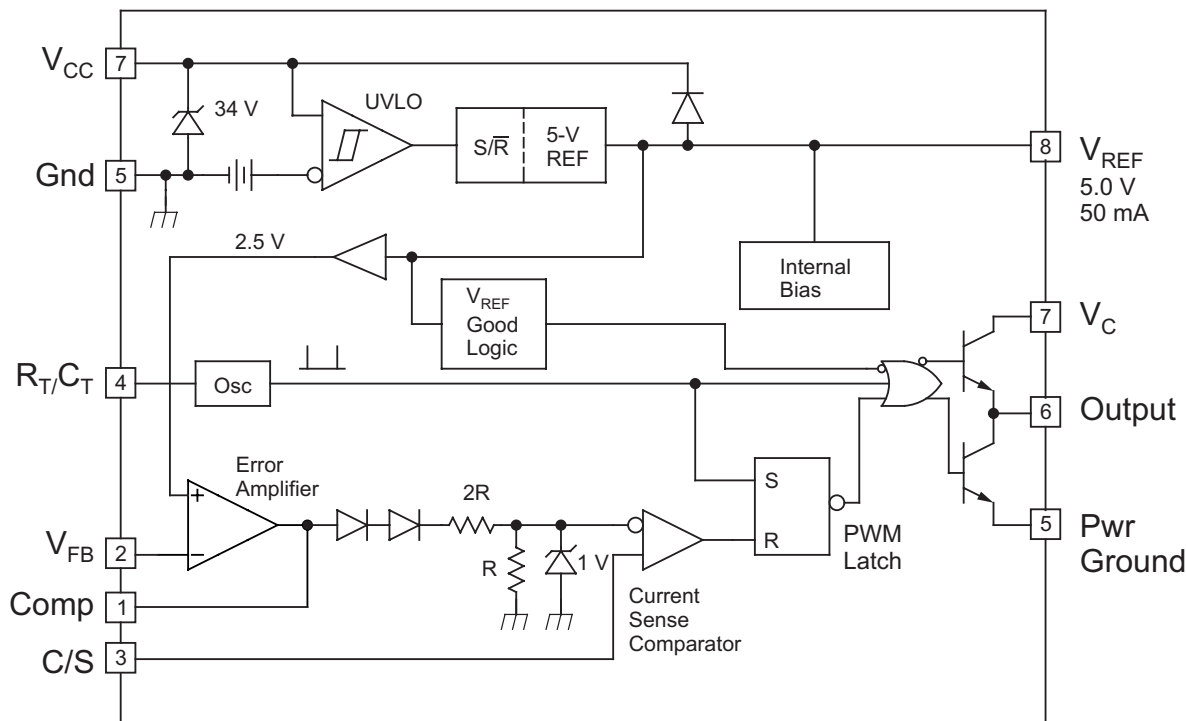
Figure 1. Output Saturation Characteristics

8 Detailed Description

8.1 Overview

The UC1845A-SP control IC is a pin-for-pin compatible improved version of the UC184x family. Providing the necessary characteristics to control current-mode switched-mode power supplies, this device has improved features. Start-up current is specified to be less than 0.5 mA and oscillator discharge is trimmed to 8.3 mA. During UVLO, the output stage can sink at least 10 mA at less than 1.2 V for V_{CC} over 5 V.

8.2 Functional Block Diagram



Copyright © 2016, Texas Instruments Incorporated

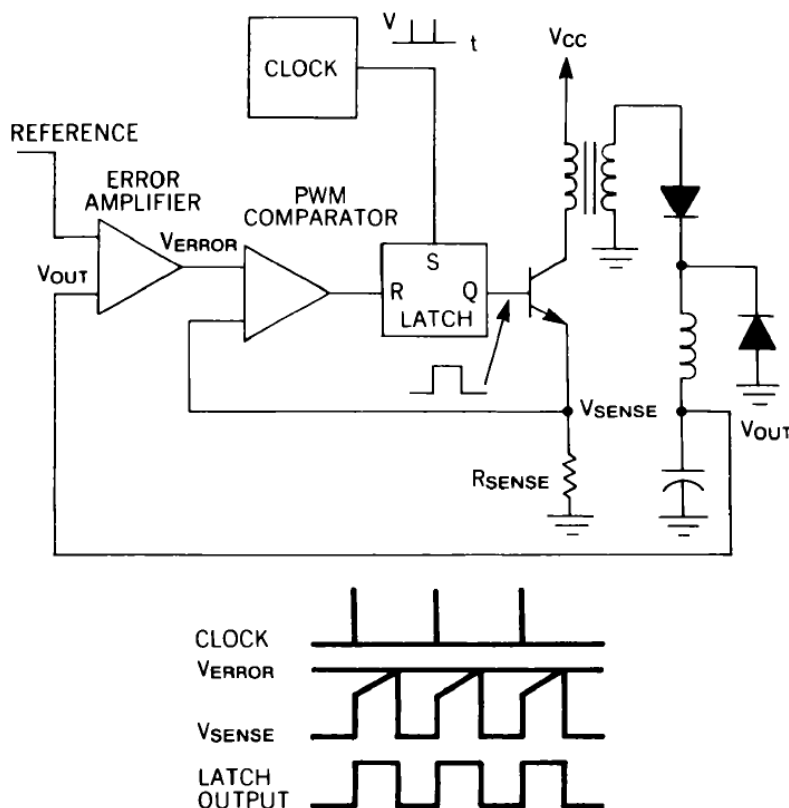
8.3 Feature Description

UC1845A-SP is a current mode controller, used to support various topologies such as forward, flyback, buck, boost and using an external interface circuit will also support half-bridge, full-bridge, and push-pull configurations.

Figure 2 shows the two-loop current-mode control system in a typical buck regulator application. A clock signal initiates power pulses at a fixed frequency. The termination of each pulse occurs when an analog of the inductor current reaches a threshold established by the error signal. In this way, the error signal actually controls peak inductor current. This contrasts with conventional schemes in which the error signal directly controls pulse width without regard to inductor current.

Several performance advantages result from the use of current-mode control. First, an input voltage feed-forward characteristic is achieved; that is, the control circuit instantaneously corrects for input voltage variations without using up any of the error amplifier's dynamic range. Therefore, line regulation is excellent and the error amplifier can be dedicated to correcting for load variations exclusively.

Feature Description (continued)



0019-1

Figure 2. Two-Loop Current-Mode Control System

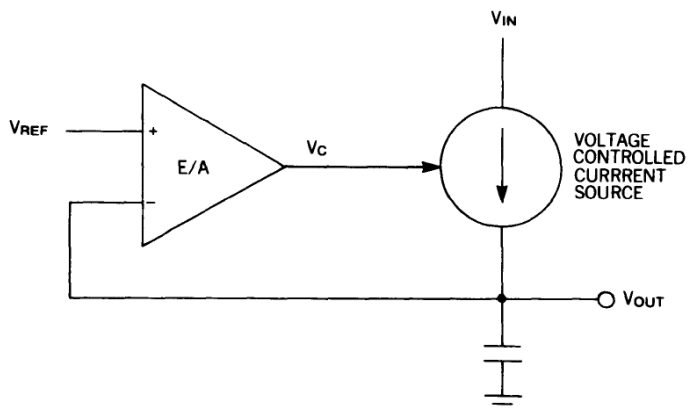
For converters in which inductor current is continuous, controlling peak current is nearly equivalent to controlling average current. Therefore, when such converters employ current-mode control, the inductor can be treated as an error-voltage-controlled-current-source for the purposes of small-signal analysis (see [Figure 3](#)). The two-pole control-to-output frequency response of these converters is reduced to a single-pole (filter capacitor in parallel with load) response. One result is that the error amplifier compensation can be designed to yield a stable closed-loop converter response with greater gain bandwidth than would be possible with pulse-width control, giving the supply improved small-signal dynamic response to changing loads. A second result is that the error amplifier compensation circuit becomes simpler, as shown in [Figure 4](#).

Capacitor C_i and resistor R_i , in [Figure 4\(A\)](#), add a low-frequency zero, which cancels one of the two control-to-output poles of non-current-mode converters. For large signal load changes, in which converter response is limited by inductor slew rate, the error amplifier saturates while the inductor is catching up with the load. During this time, C_i charges to an abnormal level. When the inductor current reaches its required level, the voltage on C_i causes a corresponding error in supply output voltage. The recovery time is $R_{iz}C_i$, which may be long. However, the compensation network of [Figure 4\(B\)](#) can be used where current-mode control has eliminated the inductor pole. Large-signal dynamic response is then greatly improved due to the absence of C_i .

Current limiting is greatly simplified with current-mode control. Pulse-by-pulse limiting is, of course, inherent in the control scheme. Furthermore, an upper limit on the peak current can be established by simply clamping the error voltage. Accurate current limiting allows optimization of magnetic and power semiconductor elements while ensuring reliable supply operation.

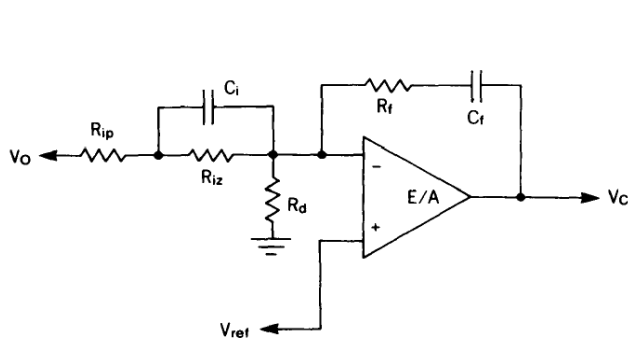
Finally, current-mode controlled power stages can be operated in parallel with equal current sharing. This opens the possibility of a modular approach to power supply design.

Feature Description (continued)



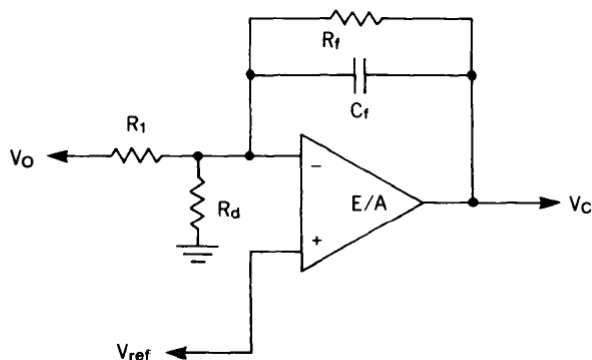
0019-2

Figure 3. Inductor Looks Like a Current Source to Small Signals



0019-3

A. Direct duty cycle control



0019-4

B. Current mode control

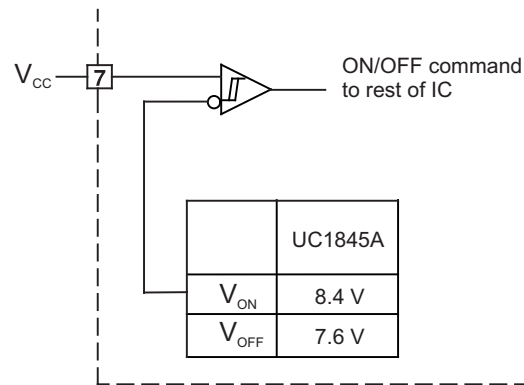
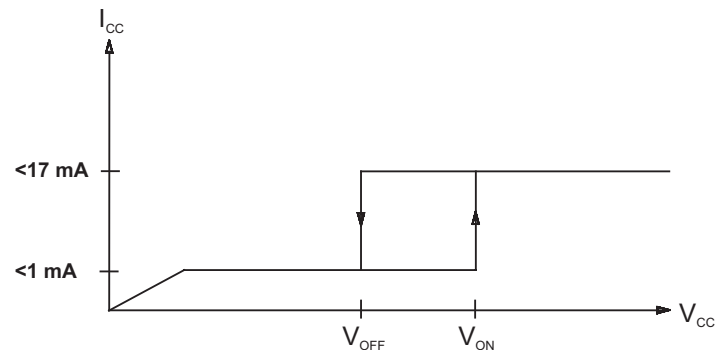
Figure 4. Required Error Amplifier Compensation for Continuous Inductor Current Designs

8.3.1 UVLO

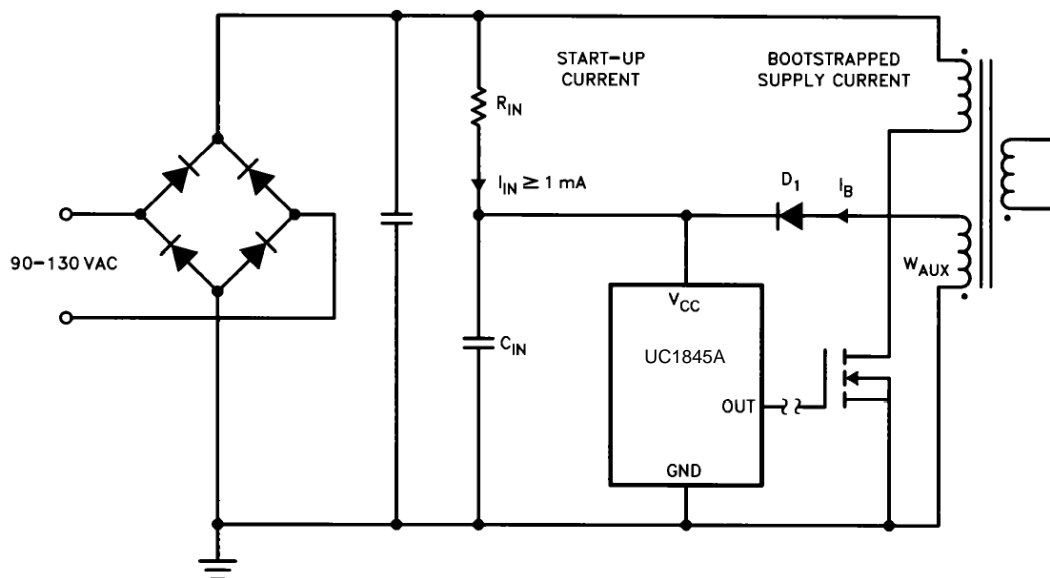
The UVLO circuit ensures that V_{CC} is adequate to make the UC1845A-SP fully operational before enabling the output stage. Figure 5 shows that the UVLO turnon and turnoff thresholds are fixed internally at 8.5 V and 7.9 V, respectively. The 0.6-V hysteresis prevents V_{CC} oscillations during power sequencing.

Figure 6 shows supply current requirements. Start-up current is < 1 mA for efficient bootstrapping from the rectified input of an off-line converter, as shown in Figure 7. During normal circuit operation, V_{CC} is developed from auxiliary winding, W_{Aux} , with D_1 and C_{IN} . However, at start-up, C_{IN} must be charged to 16 V through R_{IN} . With a start-up current of 1 mA, R_{IN} can be as large as 100 k Ω and still charge C_{IN} when $V_{AC} = 90$ -V RMS (low line). Power dissipation in R_{IN} would then be less than 350 mW even under high line ($V_{AC} = 130$ -V RMS) conditions.

During UVLO, the output driver is in a low state. While it does not exhibit the same saturation characteristics as normal operation, it can easily sink 1 mA, enough to ensure the MOSFET is held off.

Feature Description (continued)

Figure 5. UVLO Turnon TurnOff Threshold


During UVLO, the output driver is biased to sink minor amounts of current.

Figure 6. Supply Current Requirements


0019-8

Figure 7. Providing Power to the UC1845A-SP

Feature Description (continued)

8.3.2 Reference

As highlighted in the [Functional Block Diagram](#), UC1845A-SP incorporates a 5-V internal reference regulator with $\pm 2\%$ set point variation over temperature.

8.3.3 Totem-Pole Output

The UC1845A-SP PWM has a single totem-pole output which can be operated to ± 1 -A peak for driving MOSFET gates, and a +200 mA average current for bipolar power U-100A transistors. Cross conduction between the output transistors is minimal, the average added power with $V_{IN} = 30$ V is only 80 mW at 200 kHz.

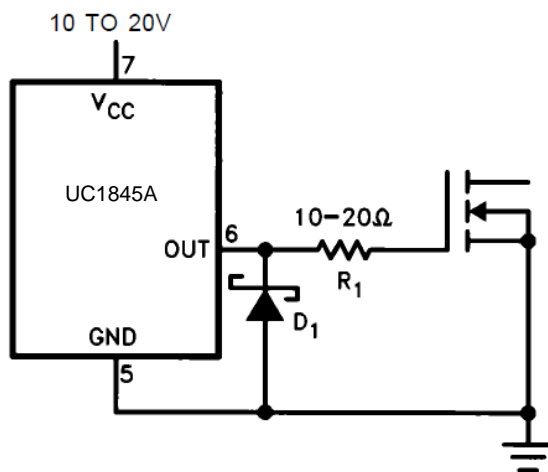
Limiting the peak current through the IC is accomplished by placing a resistor between the totem-pole output and the gate of the MOSFET. The value is determined by dividing the totem-pole collector voltage V_C by the peak current rating of the IC's totem-pole. Without this resistor, the peak current is limited only by the dV/dT rate of the totem-pole switching and the FET gate capacitance.

The use of a Schottky diode from the PWM output to ground prevents the output voltage from going excessively below ground, causing instabilities within the IC. To be effective, the diode selected should have a forward drop of less than 0.3 V at 200 mA. Most 1- to 3-A Schottky diodes exhibit these traits above room temperature. Placing the diode as physically close to the PWM as possible enhances circuit performance. Implementation of the complete drive scheme is shown in [Figure 8](#) through [Figure 10](#). Transformer-driven circuits also require the use of the Schottky diodes to prevent a similar set of circumstances from occurring on the PWM output. The ringing below ground is greatly enhanced by the transformer leakage inductance and parasitic capacitance, in addition to the magnetizing inductance and FET gate capacitance. Circuit implementation is similar to the previous example.

[Figure 8](#) through [Figure 10](#) show suggested circuits for driving MOSFETs and bipolar transistors with the UC1845A-SP output. The simple circuit of [Figure 8](#) can be used when the control IC is not electrically isolated from the MOSFET turnon and turnoff to ± 1 A. It also provides damping for a parasitic tank circuit formed by the FET input capacitance and series wiring inductance. Schottky diode, D_1 , prevents the output of the IC from going far below ground during turnoff.

[Figure 9](#) shows an isolated MOSFET drive circuit which is appropriate when the drive signal must be level shifted or transmitted across an isolation boundary. Bipolar transistors can be driven efficiently with the circuit of [Figure 10](#). Resistors R_1 and R_2 fix the on-state base current while capacitor C_1 provides a negative base current pulse to remove stored charge at turnoff.

Because the UC1845A-SP series has only a single output, an interface circuit is needed to control push-pull, half-bridge, or full-bridge topologies. The UC1706 dual output driver with internal toggle flip-flop performs this function. [Typical Application](#) shows a typical application for these two ICs. Increased drive capability for driving numerous FETs in parallel, or other loads can be accomplished using one of the UC1705/6/7 driver ICs.



0019-19

Figure 8. Direct MOSFET Drive

Feature Description (continued)

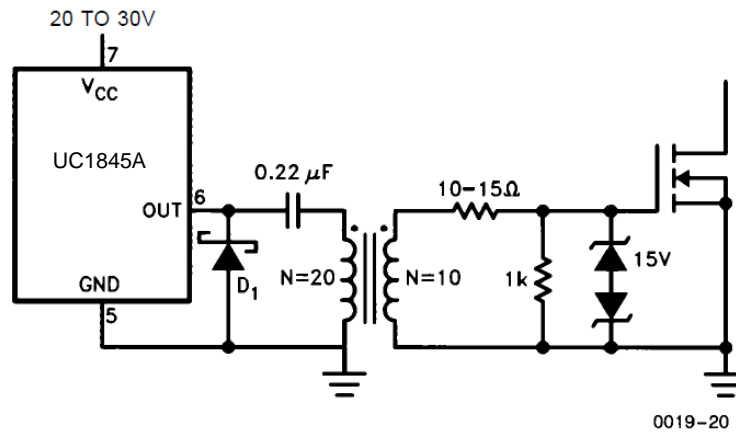


Figure 9. Isolated MOSFET Drive

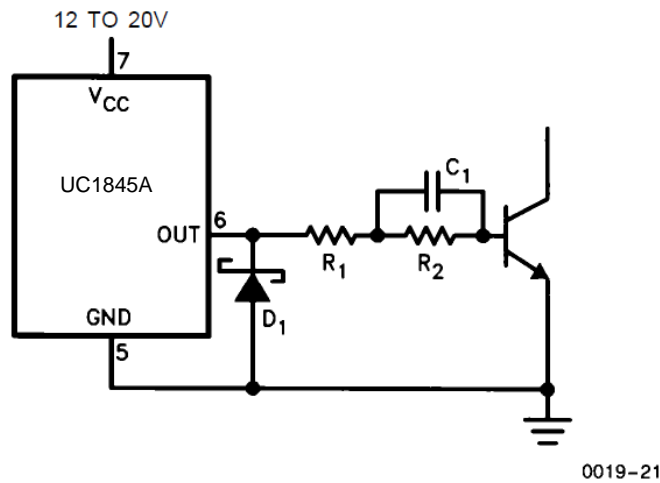


Figure 10. Bipolar Drive With Negative turnoff Bias

8.4 Device Functional Modes

The UC1845A-SP uses fixed frequency, peak current mode control. An internal oscillator initiates the turn on of the driver to high-side power switch. The external power switch current is sensed through an external resistor and is compared via internal comparator. The voltage generated at the COMP pin is stepped down via internal resistors (as shown in the functional block diagram). When the sensed current reaches the stepped down COMP voltage, the high-side power switch is turned off.

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

UC1845A-SP can be used as a controller to design various topologies such as buck, boost, flyback, and forward. Using an external interphase circuit can also support push-pull, half-bridge and full-bridge topologies.

9.2 Typical Application

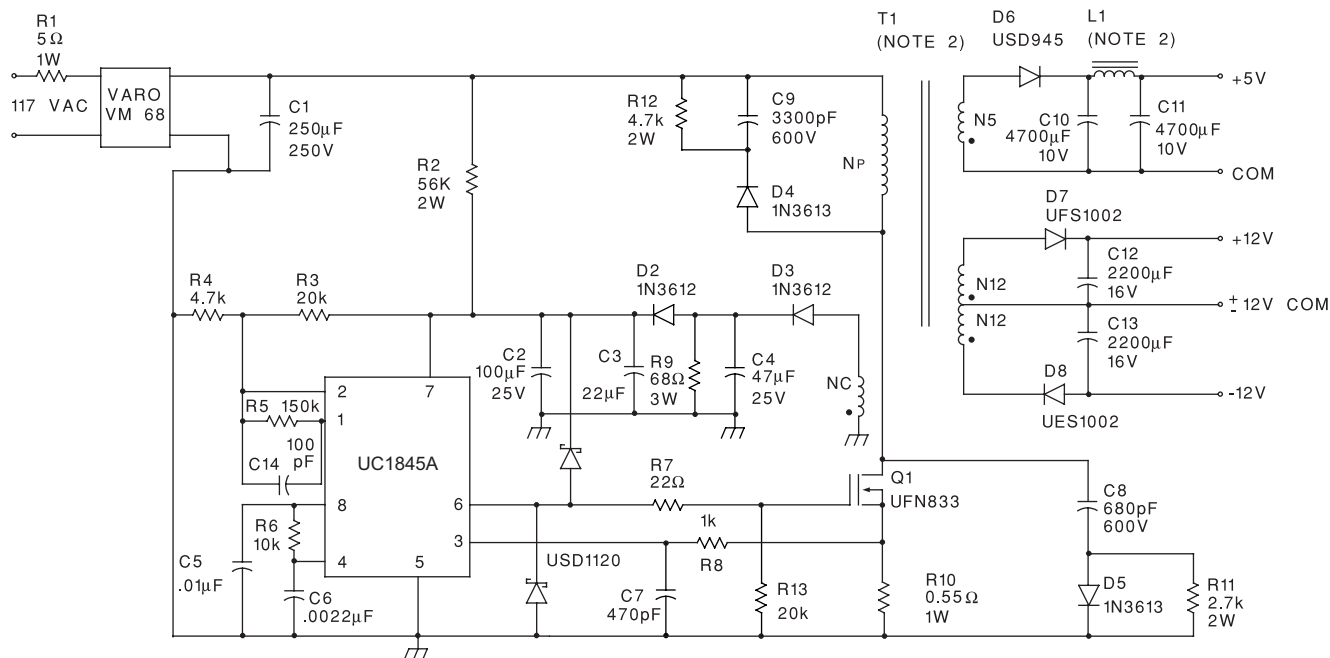


Figure 11. Typical Application Schematic

9.2.1 Design Requirements

See Table 1 for parameter values.

Table 1. Design Parameters⁽¹⁾

DESIGN PARAMETER	VALUE
Input voltage	95 VAC to 130 VAC
Line isolation	3750 V
Switching frequency	40 kHz
Efficiency (full load)	70%
Output voltage (A)	+5 V, ±5%; 1-A to 4-A load; Ripple voltage: 50-mV P-P max
Output voltage (B)	+12 V, ±3%; 0.1-A to 0.3-A load; Ripple voltage: 100-mV P-P max
Output voltage (C)	-12 V, ±3%; 0.1-A to 0.3-A load; Ripple voltage: 100-mV P-P max

(1) See Figure 11 for reference.

9.2.2 Detailed Design Procedure

See [Table 2](#) for component values.

Table 2. Components⁽¹⁾

COMPONENT	VALUE
R1	5 Ω , 1 W
R2	56 k Ω , 2 W
R3	20 k Ω
R4	4.7 k Ω
R5	150 k Ω
R6	10 k Ω
R7	22 Ω
R8	1 k Ω
R9	68 Ω
R10	0.55 Ω , 1 W
R11	2.7 k Ω , 2 W
R12	4.7 k Ω , 2 W
R13	20 k Ω
C1	250 μ F, 250 V
C2	100 μ F, 25 V
C3	22 μ F
C4	47 μ F, 25 V
C5	0.1 μ F
C6	0.0022 μ F
C7	470 pF
C8	680 pF, 600 V
C9	3300 pF, 600 V
C10	4700 μ F, 10 V
C11	4700 μ F, 10 V
C12	2200 μ F, 10 V
C13	2200 μ F, 10 V
C14	100 pF
D2	1N3612
D3	1N3612
D4	1N3613
D5	1N3613
D6	USD945
D7	UFS1002
D8	UES1002
Q1	UFN833

(1) See [Figure 11](#) for reference.

9.2.2.1 Oscillator

The UC1845A-SP oscillator is programmed as shown in [Figure 13](#). Timing capacitor C_T is charged from VREF (5 V) through the timing resistor R_T , and discharged by an internal current source. The first step in selecting the oscillator components is to determine the required circuit dead time. Once obtained, [Figure 14](#) is used to pinpoint the nearest standard value of C_T for a given dead time. Next, the appropriate R_T value is interpolated using the parameters for C_T and oscillator frequency. [Figure 15](#) shows the R_T/C_T combinations versus oscillator frequency. The timing resistor can be calculated from the following formula.

$$f_{\text{osc}} \text{ (kHz)} = \frac{1.72}{R_T \text{ (k}\Omega) \times C_T \text{ (}\mu\text{F)}} \quad (1)$$

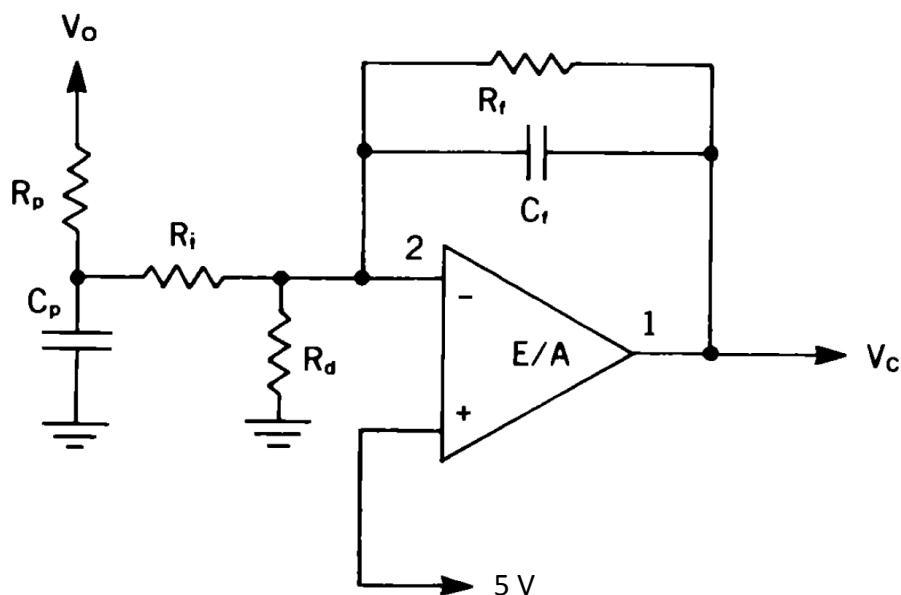


Figure 12. E/A Compensation Circuit for Continuous Boost and Flyback Topologies

The UC1845A-SP has an internal divide-by-two flip-flop driven by the oscillator for a 50% maximum duty cycle. Therefore, their oscillators must be set to run at twice the desired power supply switching frequency.

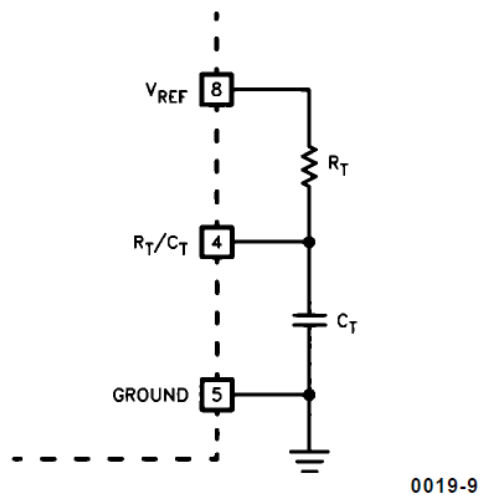
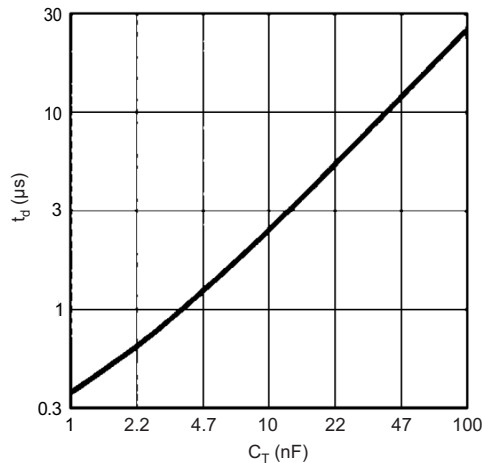
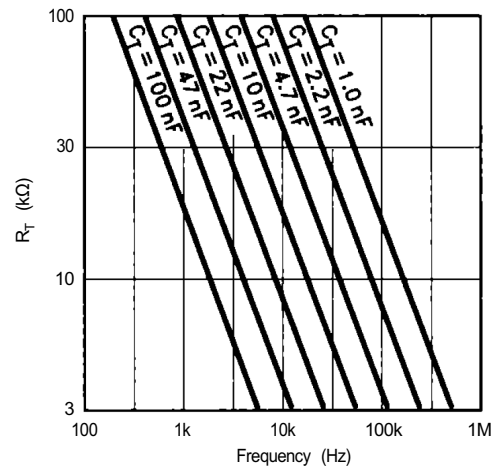


Figure 13. Oscillator Programming


Figure 14. Dead Time vs C_T (R_T > 5 kΩ)

Figure 15. Timing Resistance vs Frequency

9.2.2.2 Current Sensing and Limiting

The UC1845A-SP current sense input is configured as shown in [Figure 16](#). Current-to-voltage conversion is done externally with ground-referenced resistor R_S. Under normal operation, the peak voltage across R_S is controlled by the E/A according to the following relation:

$$I_P = \frac{V_C - 1.4 \text{ V}}{3 R_S}$$

where

- V_C = Control voltage = E/A output voltage (2)

R_S can be connected to the power circuit directly or through a current transformer, as [Figure 16](#) shows. While a direct connection is simpler, a transformer can reduce power dissipation in R_S, reduce errors caused by the base current, and provide level shifting to eliminate the restraint of ground-referenced sensing. The relation between V_C and peak current in the power stage is given by:

$$i_{(pk)} = N \left(\frac{V_{R_S(pk)}}{R_S} \right) = \frac{N}{3 R_S} (V_C - 1.4 \text{ V})$$

where

- N = Current sense transformer turns ratio = 1 when transformer not used. (3)

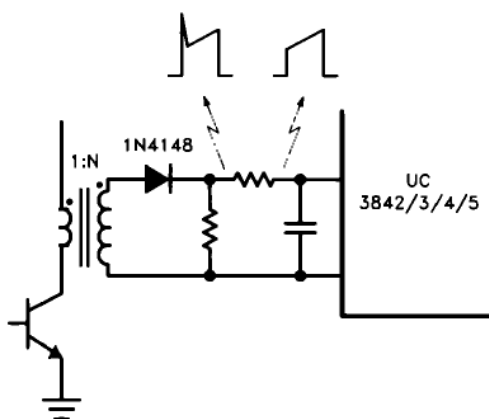
For purposes of small-signal analysis, the control-to-sensed-current gain is:

$$\frac{i_{(pk)}}{V_C} = \frac{N}{3 R_S} \quad (4)$$

When sensing current in series with the power transistor, as shown in [Figure 16](#), the current waveform often has a large spike at its leading edge. This spike is due to rectifier recovery and/or inter-winding capacitance in the power transformer. If unattenuated, this transient can prematurely terminate the output pulse. As shown, a simple RC filter is usually adequate to suppress this spike. The RC time constant should be approximately equal to the current spike duration (usually a few hundred nanoseconds).

The inverting input to the UC1845A-SP current-sense comparator is internally clamped to 1 V ([Figure 16](#)). Current limiting occurs if the voltage at pin 3 reaches this threshold value, that is, the current limit is defined by:

$$i_{max} = \frac{N \times 1 \text{ V}}{R_S} \quad (5)$$



0019-13

Figure 16. Transformer-Coupled Current Sensing

The error amplifier (E/A) configuration is shown in [Figure 17](#). The non-inverting input is not brought out to a pin, but is internally biased to 5 V \pm 2%. The E/A output is available at pin 1 for external compensation, allowing the user to control the converter's closed-loop frequency response.

Figure 18 shows an E/A compensation circuit suitable for stabilizing any current-mode controlled topology except for flyback and boost converters operating with inductor current. The feedback components add a pole to the loop transfer function at $f_p = \frac{1}{2} \pi R_F$. R_F and C_F are chosen so that this pole cancels the zero of the output filter capacitor ESR in the power circuit. R_I and R_F fix the low-frequency gain. They are chosen to provide as much gain as possible while still allowing the pole formed by the output filter capacitor and load to roll off the loop gain to unity (0 dB) at $f \approx f_{\text{SWITCHING}} / 4$. This technique ensures converter stability while providing good dynamic response.

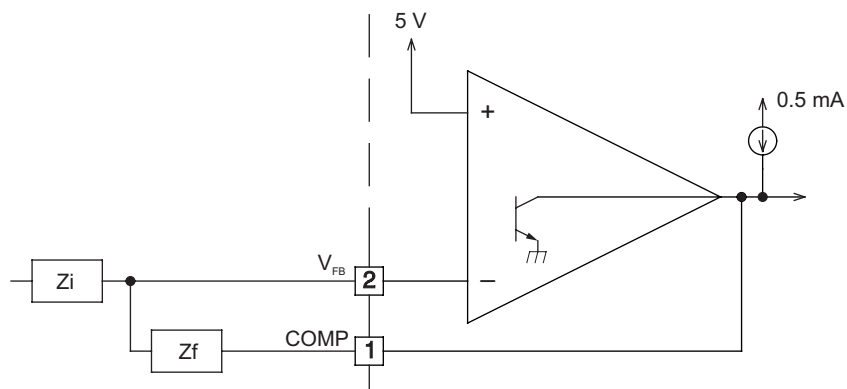
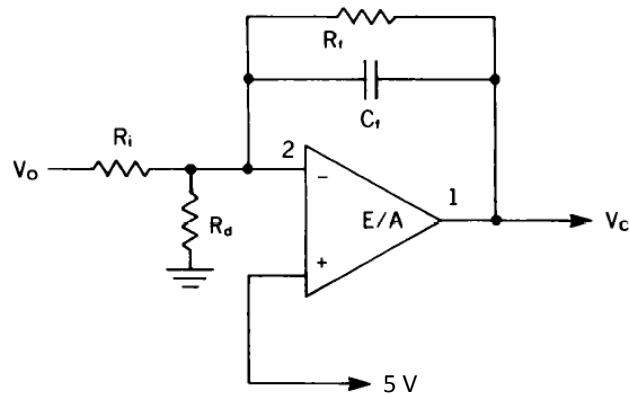


Figure 17. E/A Configuration



0019–15

Figure 18. Compensation

The E/A output sources 0.5 mA and sinks 2 mA. A lower limit for RF is given by:

$$R_{F(MIN)} \approx \frac{V_{EA\ OUT(MAX)} - 2.5\ V}{0.5\ mA} = \frac{6\ V - 2.5\ V}{0.5\ mA} = 7\ k\Omega \quad (6)$$

E/A input bias current (2-μA max) flows through Ri, resulting in a DC error in output voltage (VO) given by:

$$\Delta V_{O(MAX)} = (2\ \mu A) R_i \quad (7)$$

Therefore, the designer should keep the value of Ri, as low as possible.

Figure 19 shows the open-loop frequency response of the UC1845A-SP E/A. The gain represents an upper limit on the gain of the compensated E/A. Phase lag increases rapidly as frequency exceeds 1 MHz due to second-order poles at about 10 MHz and above.

Continuous-inductor-current boost and flyback converters each have a right-half-plane zero in their transfer function. An additional compensation pole is needed to roll off loop gain at a frequency less than that of the RHP zero. Rp and Cp in the circuit of Figure 12 provide this pole.

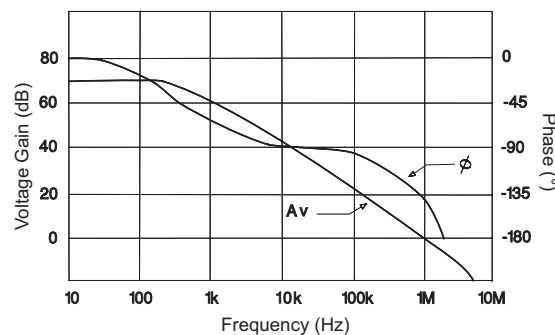


Figure 19. Error Amplifier Open-Loop Frequency Response

9.2.3 Application Curves

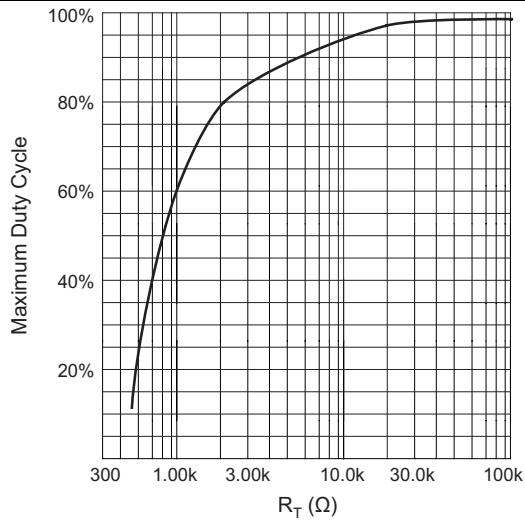


Figure 20. Oscillator Frequency vs Timing Resistance

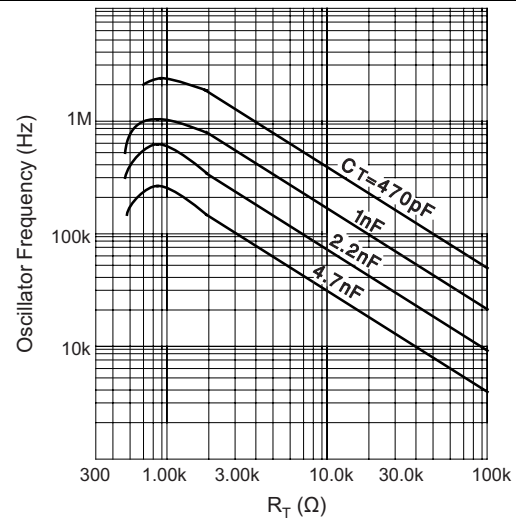
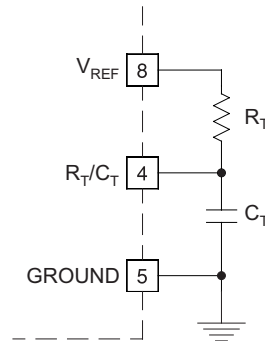


Figure 21. Maximum Duty Cycle vs Timing Resistor

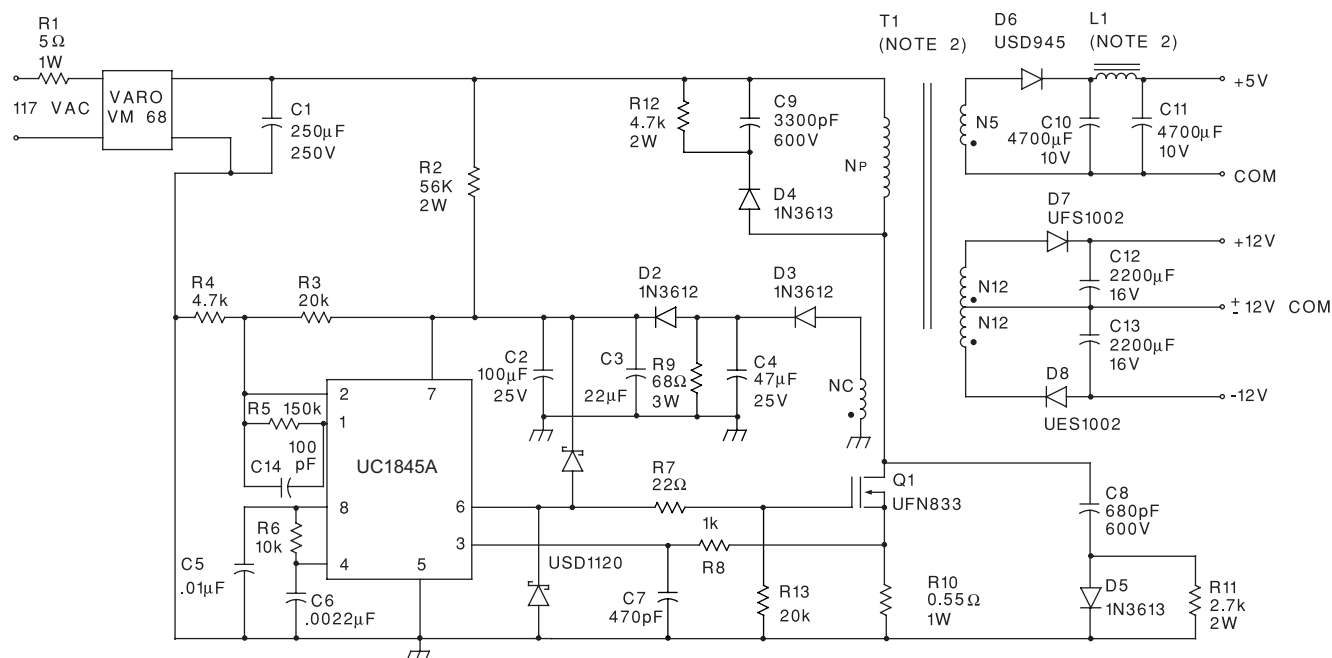


For $R_T > 5k$ $f \approx 1.72 / (R_T C_T)$

Figure 22. Oscillation Schematic

10 Power Supply Recommendations

The devices are designed to operate from an input voltage supply range between 8 V and 40 V. This input supply should be well regulated. If the input supply is located more than a few inches from the UC1845A-SP converter, additional bulk capacitance may be required in addition to the ceramic bypass capacitors. A tantalum capacitor with a value of 47 μ F is a typical choice; however, this may vary depending upon the output power being delivered.



Power supply specifications:

1. Input voltage: 95 VAC to 130 VAC (50 Hz/60 Hz)
2. Line isolation: 3750 V
3. Switching frequency: 40 kHz
4. Efficiency full load: 70%
5. Output voltage:
 - a. +5 V, $\pm 5\%$; 1- to 4-A load, ripple voltage: 50 mVP-P max
 - b. +12 V, $\pm 3\%$; 0.1- to 0.3-A load, ripple voltage: 100 mVP-P max
 - c. -12 V, $\pm 3\%$; 0.1- to 0.3-A load, ripple voltage: 100 mVP-P max

Figure 23. Offline Flyback Regulator

11 Layout

11.1 Layout Guidelines

Always try to use a low-EMI inductor with a ferrite-type closed core. Some examples would be toroid and encased E core inductors. Open core can be used if they have low-EMI characteristics and are located a farther away from the low-power traces and components. Make the poles perpendicular to the PCB as well if using an open core. Stick cores usually emit the most unwanted noise.

11.1.1 Feedback Traces

Try to run the feedback trace as far as possible from the inductor and noisy power traces. The designer should also make the feedback trace as direct as possible and somewhat thick. These two guidelines sometimes involve a trade-off, but keeping the trace away from inductor EMI and other noise sources is the more critical guideline. Run the feedback trace on the side of the PCB opposite of the inductor with a ground plane separating the two.

12 器件和文档支持

12.1 接收文档更新通知

要接收文档更新通知，请导航至 TI.com.cn 上的器件产品文件夹。单击右上角的 [通知我](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

12.2 社区资源

下列链接提供到 TI 社区资源的连接。链接的内容由各个分销商“按照原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的 [《使用条款》](#)。

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.3 商标

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

12.4 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

12.5 术语表

SLYZ022 — *TI 术语表*。

这份术语表列出并解释术语、缩写和定义。

13 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更，恕不另行通知，且不会对此文档进行修订。如需获取此数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-8670408VPA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8670408VPA UC1845A
5962-8670408VPA.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8670408VPA UC1845A
5962-8670408VXA	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 8670408VXA UC1845AL QMLV
5962-8670408VXA.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 8670408VXA UC1845AL QMLV
5962P8670411VPA	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	P8670411VPA UC1845A-SP
5962P8670411VPA.A	Active	Production	CDIP (JG) 8	50 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	P8670411VPA UC1845A-SP
5962P8670411VYC	Active	Production	CFP (HKU) 10	25 TUBE	ROHS Exempt	NIAU	N/A for Pkg Type	-55 to 125	P8670411VYC UC1845A-SP
5962P8670411VYC.A	Active	Production	CFP (HKU) 10	25 TUBE	ROHS Exempt	NIAU	N/A for Pkg Type	-55 to 125	P8670411VYC UC1845A-SP

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF UC1845A-SP :

- Catalog : [UC1845A](#)
- Enhanced Product : [UC1845A-EP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications

TUBE

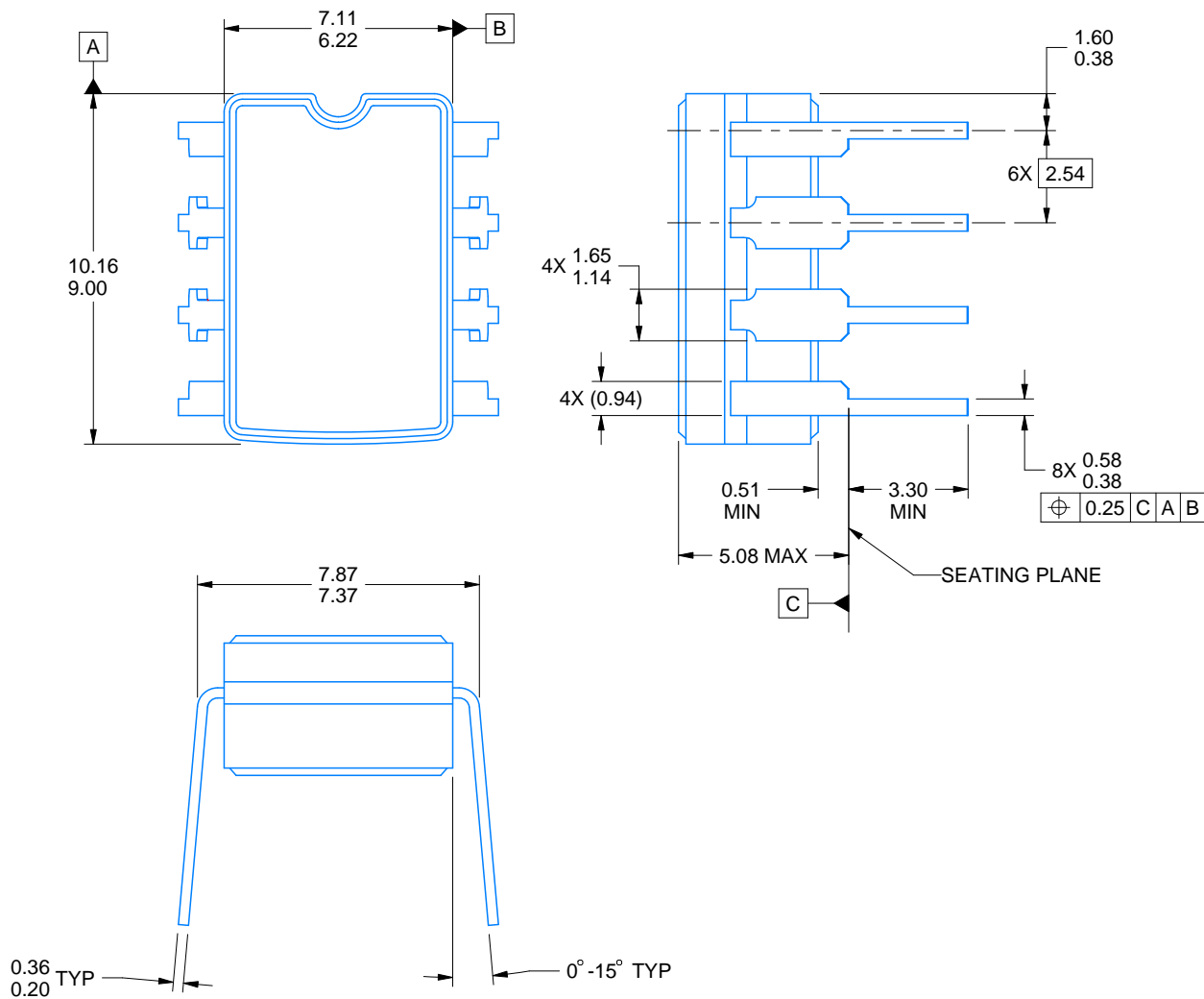


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
5962-8670408VXA	FK	LCCC	20	55	506.98	12.06	2030	NA
5962-8670408VXA.A	FK	LCCC	20	55	506.98	12.06	2030	NA
5962P8670411VPA	JG	CDIP	8	50	506.98	15.24	13440	NA
5962P8670411VPA.A	JG	CDIP	8	50	506.98	15.24	13440	NA
5962P8670411VYC	HKU	CFP	10	25	506.98	26.16	6220	NA
5962P8670411VYC.A	HKU	CFP	10	25	506.98	26.16	6220	NA

JG0008A**PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN-LINE PACKAGE



4230036/A 09/2023

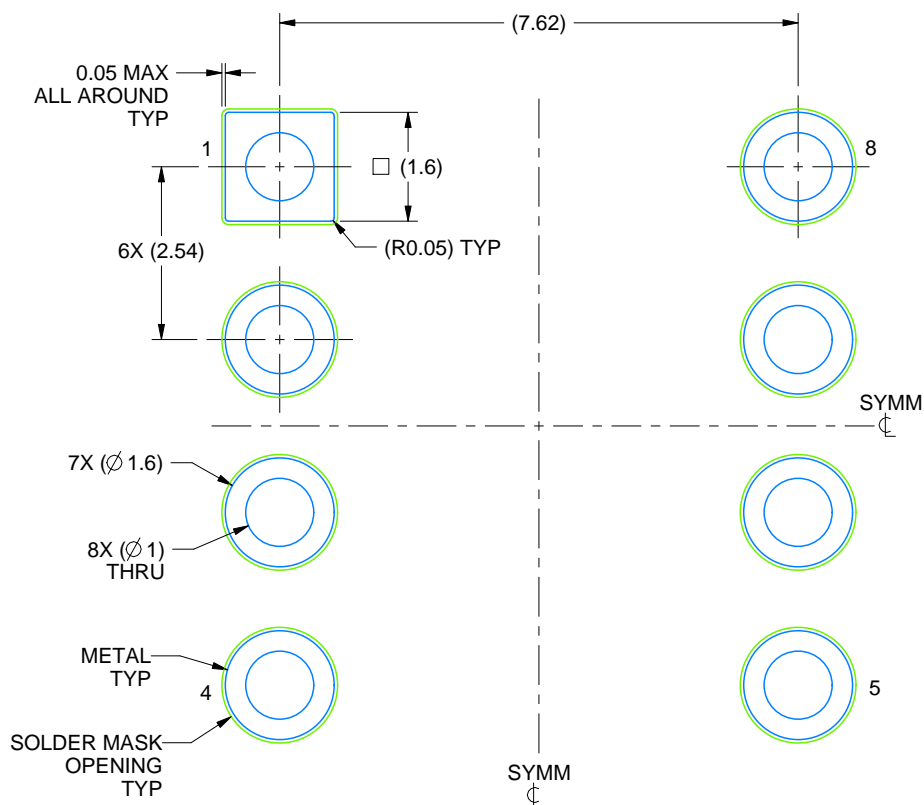
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package can be hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification.
5. Falls within MIL STD 1835 GDIP1-T8

JG0008A

CDIP - 5.08 mm max height

CERAMIC DUAL IN-LINE PACKAGE



LAND PATTERN EXAMPLE
NON SOLDER MASK DEFINED
SCALE: 9X

4230036/A 09/2023

GENERIC PACKAGE VIEW

FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4229370VA\

重要通知和免责声明

TI“按原样”提供技术和可靠性数据（包括数据表）、设计资源（包括参考设计）、应用或其他设计建议、网络工具、安全信息和其他资源，不保证没有瑕疵且不做任何明示或暗示的担保，包括但不限于对适销性、与某特定用途的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任：(1) 针对您的应用选择合适的 TI 产品，(2) 设计、验证并测试您的应用，(3) 确保您的应用满足相应标准以及任何其他安全、安保法规或其他要求。

这些资源如有变更，恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的相关应用。严禁以其他方式对这些资源进行复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。对于因您对这些资源的使用而对 TI 及其代表造成的任何索赔、损害、成本、损失和债务，您将全额赔偿，TI 对此概不负责。

TI 提供的产品受 [TI 销售条款](#)、[TI 通用质量指南](#) 或 [ti.com](#) 上其他适用条款或 TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。除非德州仪器 (TI) 明确将某产品指定为定制产品或客户特定产品，否则其产品均为按确定价格收入目录的标准通用器件。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

版权所有 © 2026，德州仪器 (TI) 公司

最后更新日期：2025 年 10 月